



L	Hits	Search Text	DB	Time stamp
Number	11100			
1	55667	EDTA	USPAT;	2002/11/13
1 -			US-PGPUB	17:04
2	39361	barrier near4 layer	USPAT;	2002/11/13
_			US-PGPUB	17:05
3	861606	tungsten W	USPAT;	2002/11/13
*			US-PGPUB	17:05
4	233452	titanium Ti	USPAT;	2002/11/13
			US-PGPUB	17:05
5	83762	tantalum TA	USPAT;	2002/11/13
			US-PGPUB	17:05
6	16341	((titanium Ti) (tantalum TA)) adj	USPAT;	2002/11/13
1		(nitride N)	US-PGPUB	17:06
7	265	(tantalum TA) adj silicon adj nitride	USPAT;	2002/11/13
			US-PGPUB	2002/11/13
8	9016	(barrier near4 layer) same ((tungsten W)	USPAT;	17:08
		(titanium Ti) (tantalum TA) (((titanium	US-PGPUB	17:00
		Ti) (tantalum TA)) adj (nitride N))		
		((tantalum TA) adj silicon adj nitride))	HCDATT-	2002/11/13
9	142	((barrier near4 layer) same ((tungsten W)	USPAT; US-PGPUB	17:10
		(titanium Ti) (tantalum TA) (((titanium	US-PGPUB	17.10
		Ti) (tantalum TA)) adj (nitride N))		
		((tantalum TA) adj silicon adj nitride)))		
		and EDTA	USPAT;	2002/11/13
10	21271	electroplating	US-PGPUB	17:10
		1441 to the second desired to the second des	USPAT;	2002/11/13
11	67	(((barrier near4 layer) same ((tungsten	US-PGPUB	19:02
		w) (titanium Ti) (tantalum TA) (((titanium Ti) (tantalum TA)) adj	US-FGFUB	13.02
1		(((titanium Ti) (tantalum TA) adj (nitride N)) ((tantalum TA) adj silicon		
		adj nitride N)) ((tantaium IA) adj Silicon adj nitride))) and EDTA) and		
		electroplating		
1,0	808	nanometers same copper	USPAT;	2002/11/13
12	800	Manometers same copper	US-PGPUB	18:49
12	152	(nanometers same copper) and	USPAT;	2002/11/13
13	132	electroplating	US-PGPUB	18:49
14	0	(barrier near4 layer) near2 bipyridyl	USPAT;	2002/11/13
14		(ballici meali lajor) moali a-pja-aj-	US-PGPUB	18:49
15	1524	bipyridyl	USPAT;	2002/11/13
13	1023		US-PGPUB	18:50
16	1	bipyridyl and ((nanometers same copper)	USPAT;	2002/11/13
	_	and electroplating)	US-PGPUB	18:50
17	235		USPAT;	2002/11/13
1			US-PGPUB	18:51
18	13	(bipyridyl and EDTA) and electroplating	USPAT;	2002/11/13
		and copper	US-PGPUB	18:53
19	1	("6300244").PN.	USPAT;	2002/11/13
	1		US-PGPUB	18:55
20	0	("19 and 12").PN.	USPAT;	2002/11/13
			US-PGPUB	18:55
21	0	("19 and 15").PN.	USPAT;	2002/11/13
			US-PGPUB	18:55 2002/11/13
22	1754	cyanide same ions	USPAT;	19:03
		1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1	US-PGPUB USPAT;	2002/11/13
23	8	(cyanide same ions) and ((((barrier near4	1	19:03
	1	layer) same ((tungsten W) (titanium Ti)	US-PGPUB	19.03
		(tantalum TA) (((titanium Ti) (tantalum		
		TA)) adj (nitride N)) ((tantalum TA) adj		
		silicon adj nitride))) and EDTA) and		
	1	electroplating)	<u></u>	_1,





L	Hits	Search Text	DB	Time stamp
Number	į			
1	55667	EDTA	USPAT;	2002/11/13
			US-PGPUB	17:04
2	39361	barrier near4 layer	USPAT;	2002/11/13
			US-PGPUB	17:05
3	861606	tungsten W	USPAT;	2002/11/13
			US-PGPUB	17:05
4	233452	titanium Ti	USPAT;	2002/11/13
			US-PGPUB	17:05
5	83762	tantalum TA	USPAT;	2002/11/13
			US-PGPUB	17:05
6	16341	((titanium Ti) (tantalum TA)) adj	USPAT;	2002/11/13
		(nitride N)	US-PGPUB	17:06
7	265	(tantalum TA) adj silicon adj nitride	USPAT;	2002/11/13
			US-PGPUB	17:07
8	9016	(barrier near4 layer) same ((tungsten W)	USPAT;	2002/11/13
	·	(titanium Ti) (tantalum TA) (((titanium	US-PGPUB	17:08
		Ti) (tantalum TA)) adj (nitride N))		
		((tantalum TA) adj silicon adj nitride))		
9	142		USPAT;	2002/11/13
		(titanium Ti) (tantalum TA) (((titanium	US-PGPUB	17:10
		Ti) (tantalum TA)) adj (nitride N))		
		((tantalum TA) adj silicon adj nitride)))		
		and EDTA		
10	21271	electroplating	USPAT;	2002/11/13
			US-PGPUB	17:10
11	67	(((barrier near4 layer) same ((tungsten	USPAT;	2002/11/13
		W) (titanium Ti) (tantalum TA)	US-PGPUB	17:11
		(((titanium Ti) (tantalum TA)) adj		
		(nitride N)) ((tantalum TA) adj silicon		
		adj nitride))) and EDTA) and	•	
		electroplating	<u> </u>	